



News Release

Business is back to normal at Unisem Chengdu factory

Kuala Lumpur - 16 May 2008: Further to our news release of 13 May 2008, we wish to inform all our stakeholders that business is back to normal at our Chengdu facility.

The factory building has been officially certified as undamaged and all utility supplies are back to normal. Chengdu International Airport and customs are in operation and all our incoming and outgoing shipments have resumed. We have resumed production with all assembly and test process areas up and running. We expect to be back to full operations by 18 May 2008.

About Unisem

Unisem is a global provider of semiconductor assembly and test services for many of the world's most successful electronics companies. Unisem offers an integrated suite of packaging and test services such as wafer bumping, wafer probing, wafer grinding, a wide range of leadframe and substrate IC packaging, wafer level CSP and RF, analog, digital and mixed-signal test services. Our turnkey services include design, assembly, test, failure analysis, and electrical and thermal characterization. With approximately 9,500 employees worldwide, Unisem has factory locations in Ipoh, Malaysia; Wales, United Kingdom; Chengdu, People's Republic of China; Batam, Indonesia and Sunnyvale, USA. The company is headquartered in Kuala Lumpur, Malaysia. For more information about the company, its products and services, please visit its website at www.unisemgroup.com.